

# BUL1101E

## HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

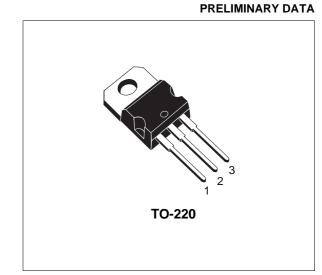
- HIGH VOLTAGE CAPABILITY
- LOW SPREAD OF DYNAMIC PARAMETERS
- MINIMUM LOT-TO-LOT SPREAD FOR RELIABLE OPERATION
- VERY HIGH SWITCHING SPEED
- LARGE RBSOA

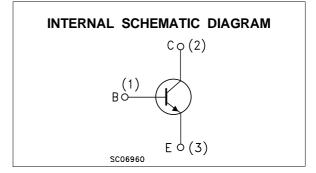
#### **APPLICATIONS**

 ELECTRONIC BALLASTS FOR FLUORESCENT LIGHTING

#### DESCRIPTION

The device is manufactured using High Voltage Multi Epitaxial Planar technology for high switching speeds and high voltage capability. It uses a Cellular Emitter structure with planar edge termination to enhance switching speeds while maintaining a wide RBSOA.





#### ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit	
V <sub>CES</sub>	Collector-Emitter Voltage (V <sub>BE</sub> = 0)	1100	V	
$V_{CEO}$	Collector-Emitter Voltage $(I_B = 0)$	450	V	
V <sub>EBO</sub>	Emitter-Base Voltage $(I_C = 0)$	V <sub>(BR)EBO</sub>	V	
lc	Collector Current	3	А	
Ісм	Collector Peak Current (t <sub>p</sub> <5 ms)	6	А	
Ι <sub>Β</sub>	Base Current	1.5	А	
I <sub>BM</sub>	Base Peak Current (t <sub>p</sub> <5 ms)	3	А	
Ptot	Total Dissipation at Tc = 25 °C	70	W	
T <sub>stg</sub>	Storage Temperature	-65 to 150	°C	
Tj	Max. Operating Junction Temperature	150	°C	

### THERMAL DATA

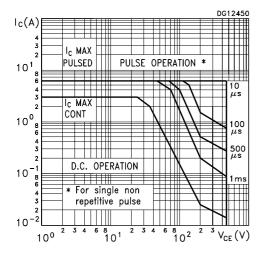
R <sub>thj-case</sub>	Thermal Resistance Junction-Case	Max	1.78	°C/W
$R_{thj-amb}$	Thermal Resistance Junction-ambient	Max	62.5	°C/W

## **ELECTRICAL CHARACTERISTICS** ( $T_{case} = 25 \ ^{\circ}C$ unless otherwise specified)

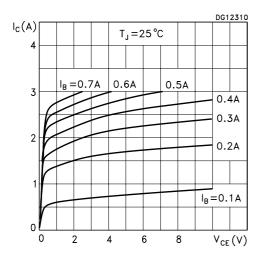
Symbol	Parameter	Test Co	nditions	Min.	Тур.	Max.	Unit
ICES	Collector Cut-off Current (V <sub>BE</sub> = 0)	V <sub>CE</sub> = 1100 V				100	μA
V <sub>(BR)EBO</sub>	Emitter-Base Breakdown Voltage (Ic = 0)	I <sub>E</sub> = 1 mA		12		24	V
$V_{CEO(sus)^*}$	Collector-Emitter Sustaining Voltage (I <sub>B</sub> = 0)	I <sub>C</sub> = 100 mA		450			V
V <sub>CE(sat)</sub> *	Collector-Emitter Saturation Voltage	I <sub>C</sub> = 1 A	I <sub>B</sub> = 200 mA		0.25	1	V
V <sub>BE(sat)</sub> *	Base-Emitter Saturation Voltage	I <sub>C</sub> = 1 A	I <sub>B</sub> = 200 mA			1.5	V
h <sub>FE</sub> *	DC Current Gain	I <sub>C</sub> = 250 mA I <sub>C</sub> = 2 A	V <sub>CE</sub> = 5 V V <sub>CE</sub> = 5 V	20 6	38 10	60 15	
ts t <sub>f</sub>	RESISTIVE LOAD Storage Time Fall Time		V <sub>CC</sub> = 125 V t <sub>P</sub> = 300 μs		400	2 700	μs ns
Ear	Repetitive Avalanche Energy	$\begin{array}{l} L=2 \mbox{ mH} \\ I_{BR} \leq 2.5 A \end{array}$	C = 1.8 nF (see figure 2)	6			mJ

\* Pulsed: Pulse duration =  $300 \,\mu$ s, duty cycle 1.5 %

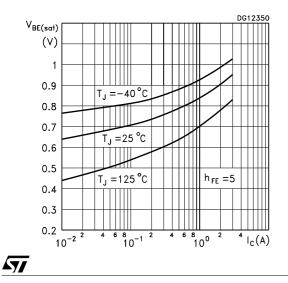
#### Safe Operating Area



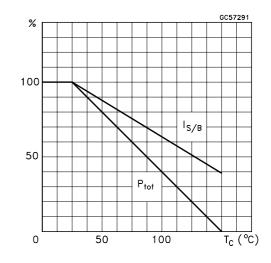
#### **Output Characteristics**



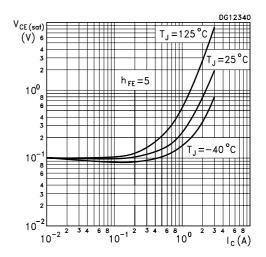
#### **Base-Emitter Saturation Voltage**



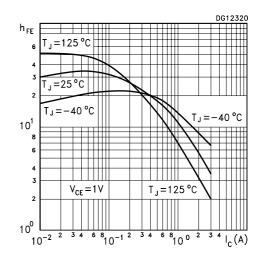
#### **Derating Curve**



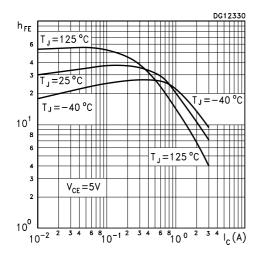
#### Collector-Emitter Saturation Voltage



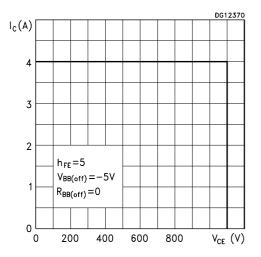
#### DC Current Gain



#### DC Current Gain



Reverse Biased Safe Operating Area



**Resistive Load Switching Times** 

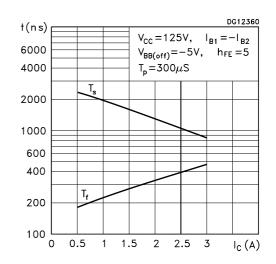


Figure 1: Resistive Load Switching Test Circuit

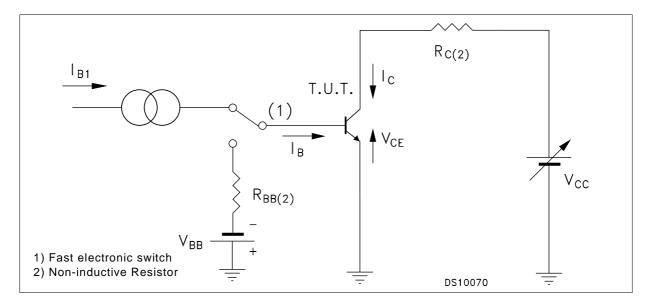
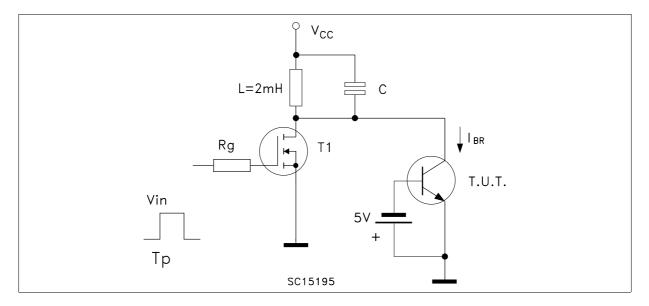


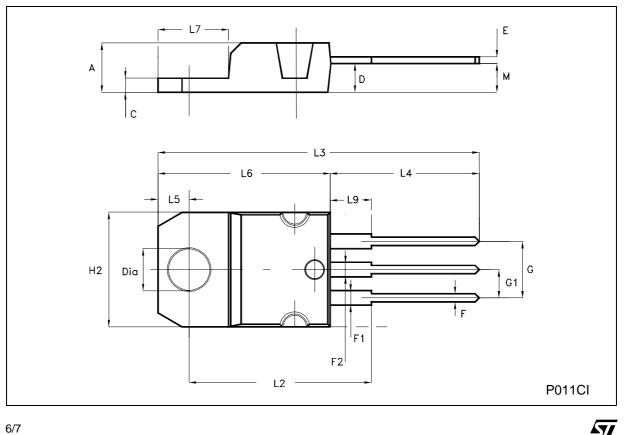
Figure 2: Energy Rating Test Circuit



### BUL1101E

DIM.		mm		inch			
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
А	4.40		4.60	0.173		0.181	
С	1.23		1.32	0.048		0.052	
D	2.40		2.72	0.094		0.107	
Е	0.49		0.70	0.019		0.027	
F	0.61		0.88	0.024		0.034	
F1	1.14		1.70	0.044		0.067	
F2	1.14		1.70	0.044		0.067	
G	4.95		5.15	0.194		0.202	
G1	2.40		2.70	0.094		0.106	
H2	10.00		10.40	0.394		0.409	
L2		16.40			0.645		
L4	13.00		14.00	0.511		0.551	
L5	2.65		2.95	0.104		0.116	
L6	15.25		15.75	0.600		0.620	
L7	6.20		6.60	0.244		0.260	
L9	3.50		3.93	0.137		0.154	
Μ		2.60			0.102		

## **TO-220 MECHANICAL DATA**



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